

N-Channel Power MOSFET

50V, 260mA, 2.5Ω

FEATURES

- Low $R_{DS(ON)}$ to minimize conductive losses
- Logic level
- Low gate charge for fast power switching
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

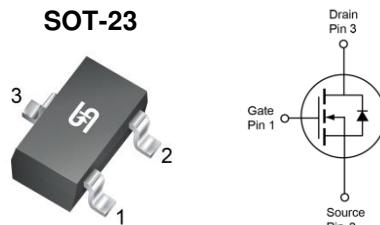
- Low Side Load Switching
- Level Shift Circuits
- General Switch Circuits

KEY PERFORMANCE PARAMETERS		
PARAMETER	VALUE	UNIT
V_{DS}	50	V
$R_{DS(on)}$ (max)	$V_{GS} = 10V$	2.5
	$V_{GS} = 4.5V$	3
Q_g	1	nC



✓
RoHS
COMPLIANT

HALOGEN
FREE



Note: MSL 1 (Moisture Sensitivity Level) per J-STD-020

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ unless otherwise noted)			
PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V_{DS}	50	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current <small>(Note 1)</small>	I_D	260	mA
		117	
Pulsed Drain Current	I_{DM}	1.04	A
Total Power Dissipation	P_D	357	mW
		71	
Operating Junction and Storage Temperature Range	T_J, T_{STG}	- 55 to +150	°C

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	MAXIMUM	UNIT
Junction to Ambient Thermal Resistance	$R_{\Theta JA}$	350	°C/W

Thermal Performance Note: $R_{\Theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JC}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design. The $R_{\Theta JA}$ limit presented here is based on mounting on a 1 in² pad of 2 oz copper.

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ C$ unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	BV_{DSS}	50	--	--	V
Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250\mu A$	$V_{GS(TH)}$	0.8	1.1	1.6	V
Gate-Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$	I_{GSS}	--	--	± 100	nA
Drain-Source Leakage Current	$V_{GS} = 0V, V_{DS} = 50V$	I_{DSS}	--	--	1	μA
	$V_{GS} = 0V, V_{DS} = 50V$ $T_J = 125^\circ C$		--	--	100	
Drain-Source On-State Resistance (Note 3)	$V_{GS} = 10V, I_D = 260mA$	$R_{DS(on)}$	--	1.1	2.5	Ω
	$V_{GS} = 4.5V, I_D = 240mA$		--	1.2	3	
Forward Transconductance (Note 3)	$V_{DS} = 5V, I_D = 260mA$	g_{fs}	--	0.8	--	S
Dynamic (Note 3)						
Total Gate Charge	$V_{GS} = 10V, V_{DS} = 25V,$ $I_D = 260mA$	Q_g	--	2	--	nC
Total Gate Charge	$V_{GS} = 4.5V, V_{DS} = 25V,$ $I_D = 240mA$	Q_g	--	1	--	
Gate-Source Charge		Q_{gs}	--	0.3	--	
Gate-Drain Charge		Q_{gd}	--	0.3	--	
Input Capacitance	$V_{GS} = 0V, V_{DS} = 25V$ $f = 1.0MHz$	C_{iss}	--	32	--	pF
Output Capacitance		C_{oss}	--	10	--	
Reverse Transfer Capacitance		C_{rss}	--	6	--	
Switching (Note 3)						
Turn-On Delay Time	$V_{GS} = 10V, V_{DS} = 25V,$ $I_D = 260mA, R_G = 6\Omega$	$t_{d(on)}$	--	3	--	ns
Turn-On Rise Time		t_r	--	11	--	
Turn-Off Delay Time		$t_{d(off)}$	--	20	--	
Turn-Off Fall Time		t_f	--	48	--	
Source-Drain Diode						
Forward Voltage (Note 2)	$V_{GS} = 0V, I_S = 260mA$	V_{SD}	--	--	1.2	V
Reverse Recovery Time	$I_S = 260mA,$ $dI/dt = 100A/\mu s$	t_{rr}	--	13	--	ns
Reverse Recovery Charge		Q_{rr}	--	4	--	nC

Notes:

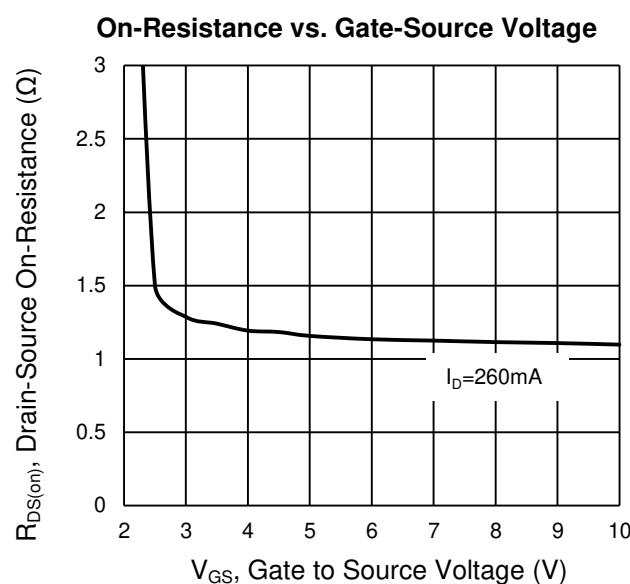
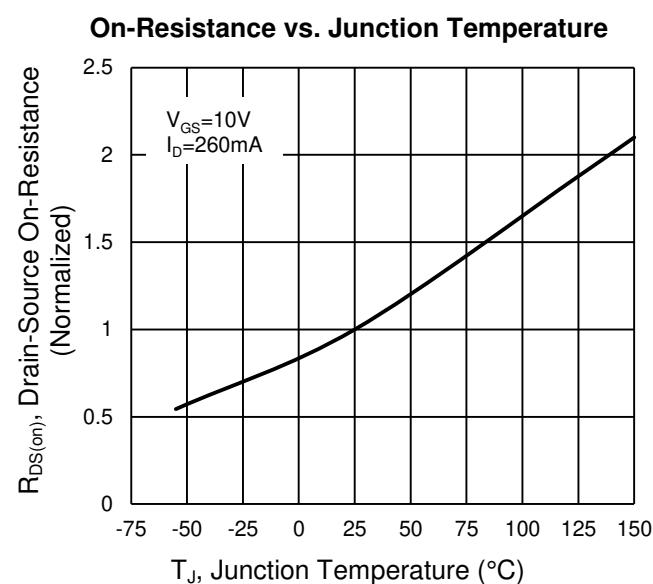
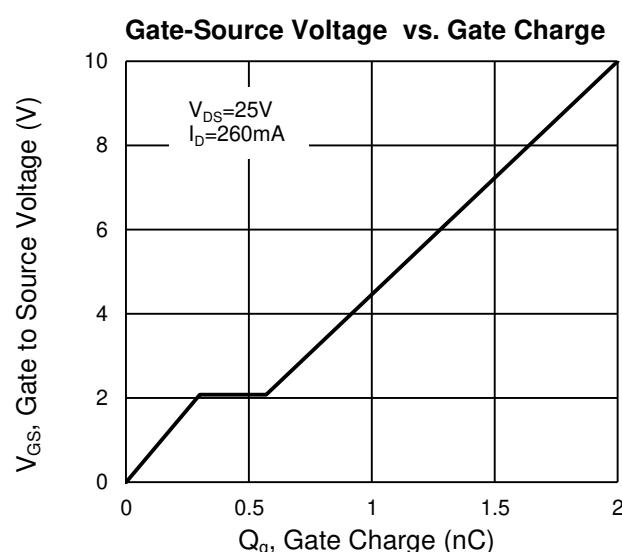
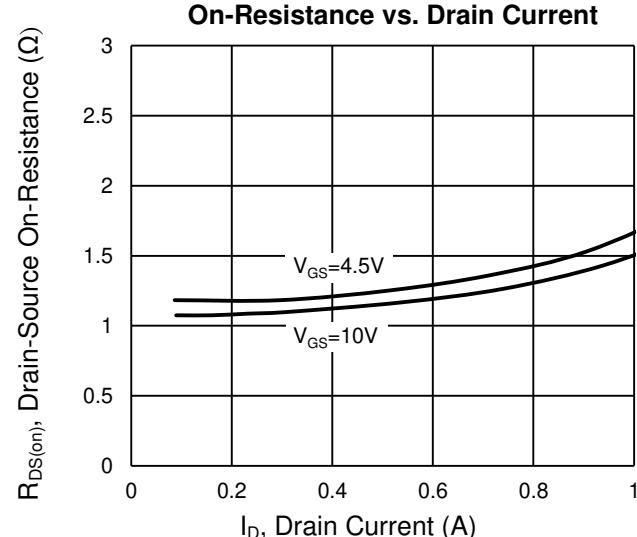
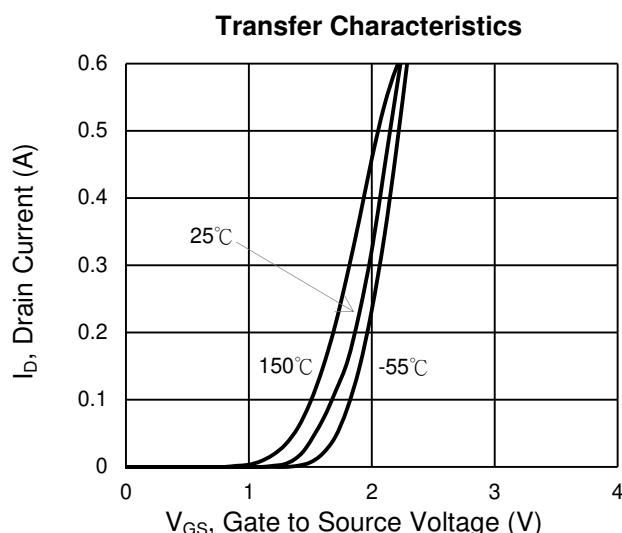
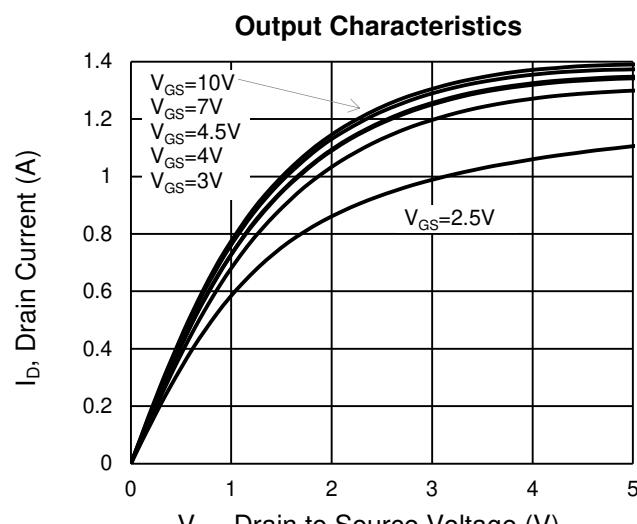
1. Silicon limited current only.
2. Pulse test: Pulse Width $\leq 300\mu s$, duty cycle $\leq 2\%$.
3. Switching time is essentially independent of operating temperature.

ORDERING INFORMATION

ORDERING CODE	PACKAGE	PACKING
BSS138 RFG	SOT-23	3,000pcs / 7" Reel

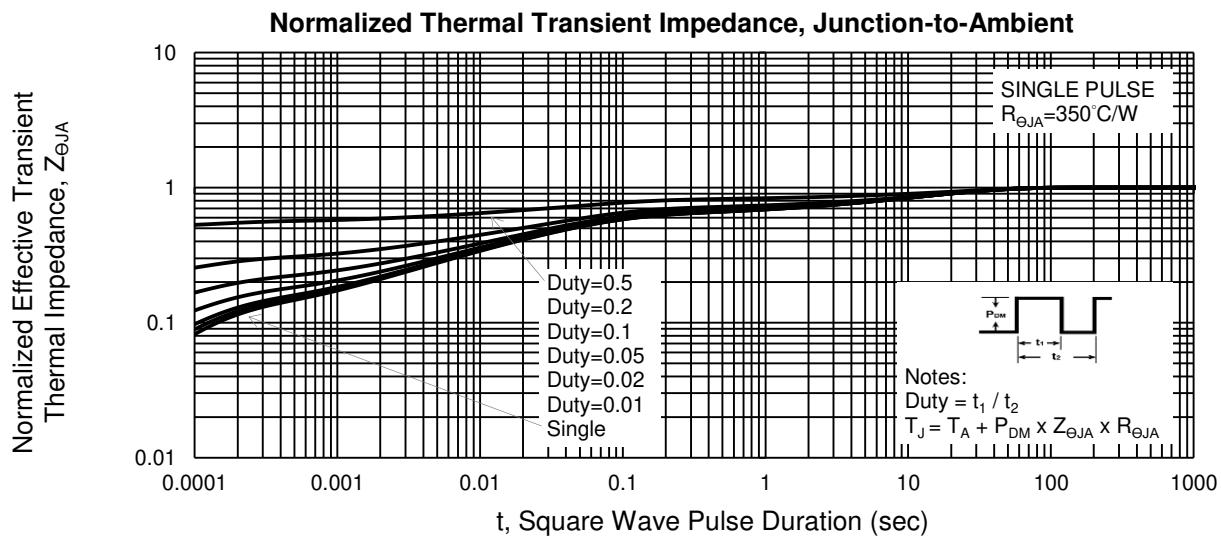
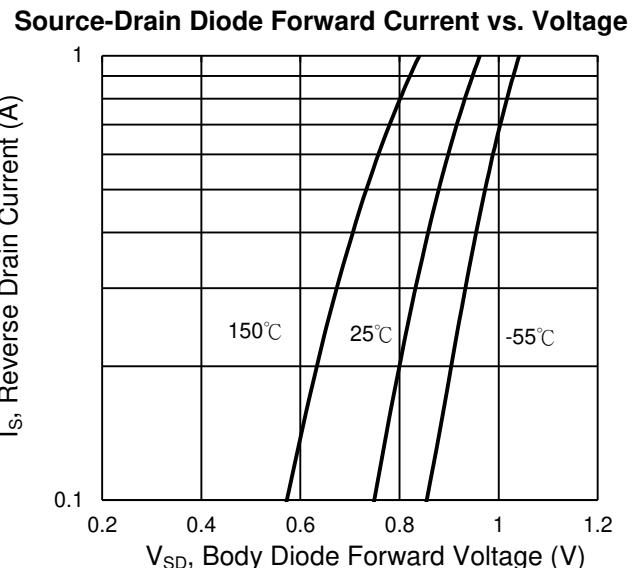
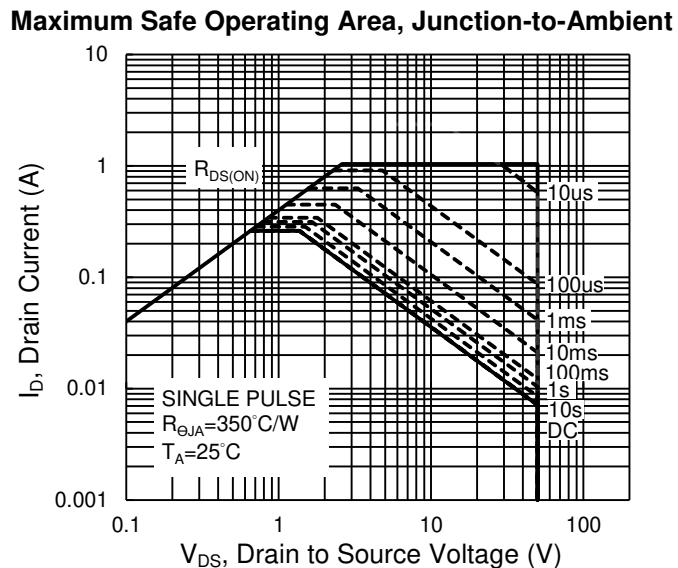
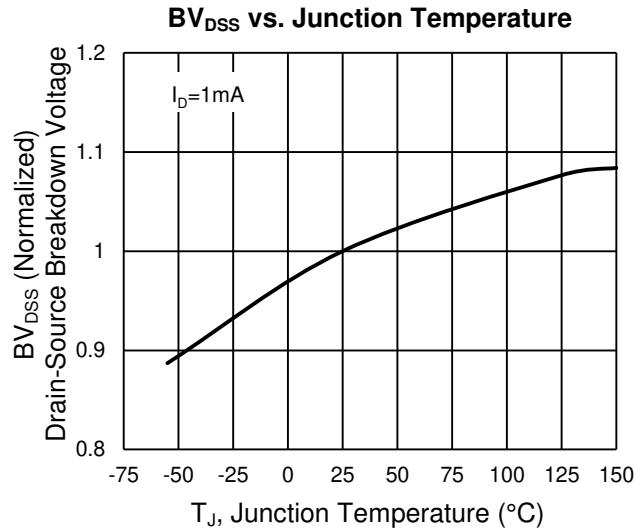
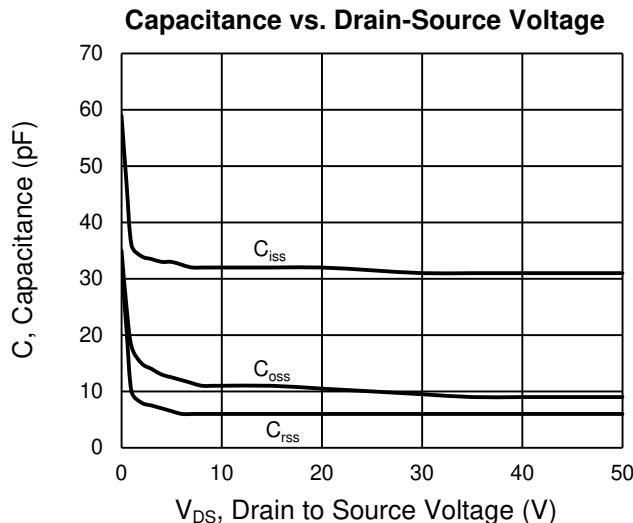
CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

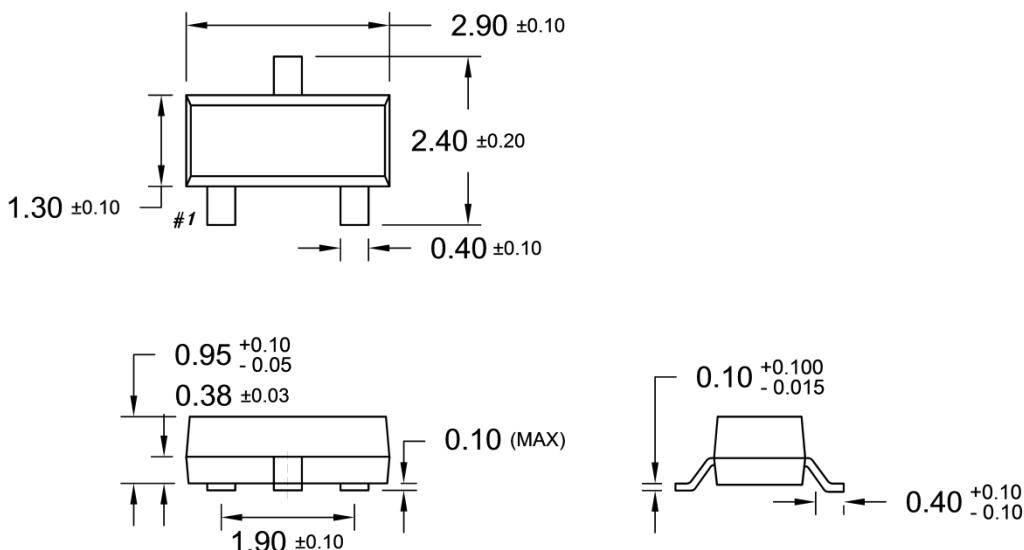
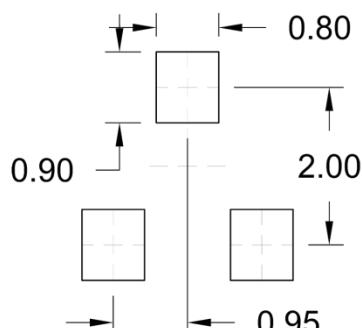
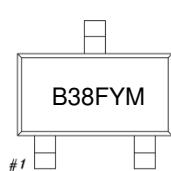


CHARACTERISTICS CURVES

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PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

SOT-23

SUGGESTED PAD LAYOUT (Unit: Millimeters)

MARKING DIAGRAM


B38	= Device code
F	= Site Code
Y	= Year Code
M	= Month code
O	=Jan
P	=Feb
Q	=Mar
R	=Apr
S	=May
T	=Jun
U	=Jul
V	=Aug
W	=Sep
X	=Oct
Y	=Nov
Z	=Dec

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